# **Applications**

- IPM Interface Isolation
- Isolated IGBT/MOSFET Gate Drive
- AC and Brushless DC Motor Drives
- Industrial Inverters
- General Digital Isolation

### **Ordering Information**

ACPL-M483/P483/W483 is UL recognized with 3750/3750/5000V<sub>RMS</sub>/1 minute rating per UL 1577, respectively.

Part Number	Option	Package	Surface Mount	Tape and Reel	IEC/EN/DIN EN	Quantity
Part Number	RoHS Compliant	гаскаде	Surface Mount	iape allu keel	60747-5-5	Quantity
	-000E		X			100 per tube
ACPL-M483	-500E	Stretched	Х	Х		1500 per reel
ACPL-IVI403	-060E	SO-5	Х		Х	100 per tube
	-560E		X	Х	Х	1500 per reel
	-000E		Х			100 per tube
ACPL-P483	-500E	Stretched	X	Х		1000 per reel
ACPL-W483	-060E	SO-6	X		Х	100 per tube
	-560E		Х	Х	Х	1000 per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an ordering part number.

- Example 1: ACPL-P483-560E: Stretched SO-6 Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-5 Safety Approval and RoHS compliant.
- Example 2: ACPL-P483-000E to order product of Stretched SO-6 Surface Mount package in Tube packaging and RoHS compliant.
- Example 3: ACPL-M483-000E to order product of SO-5 Surface Mount package in Tube packaging and RoHS compliant.

Option data sheets are available. Contact your Broadcom sales representative or authorized distributor for information.

### **Recommended Pb-Free IR Profile**

The recommended reflow profile is per JEDEC Standard, J-STD-020 (latest revision). Non-halide flux should be used.

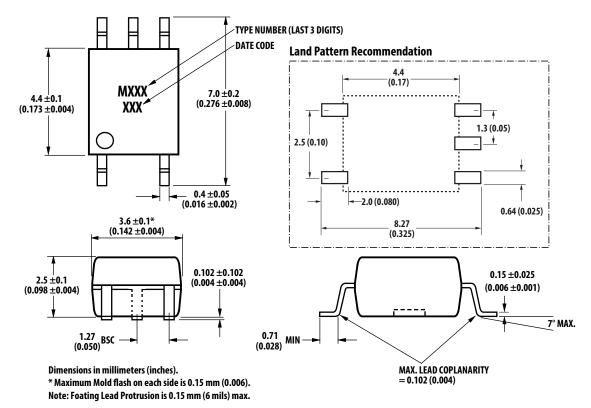
# **Regulatory Information**

The ACPL-M483/P483/W483 is approved by the following organizations:

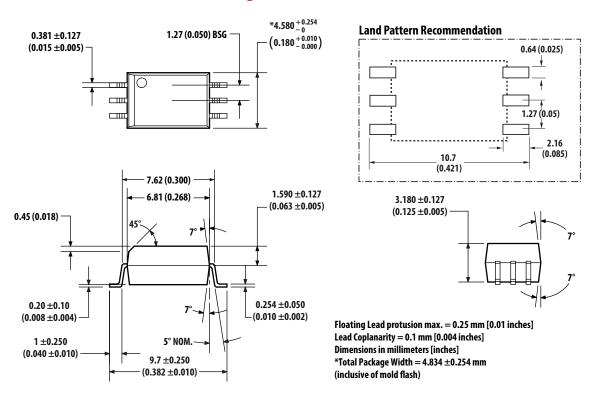
- IEC/EN/DIN EN 60747-5-5 (Option 060 only): Approved with Maximum Working Insulation Voltage V<sub>IORM</sub> = 567V<sub>peak</sub> for ACPL-M483, V<sub>IORM</sub> = 891V<sub>peak</sub> for ACPL-P483, and V<sub>IORM</sub> = 1140V<sub>peak</sub> for ACPL-W483.
- UL: Approval under UL 1577, component recognition program up to  $V_{ISO} = 3750V_{RMS}$  File E55361 for ACPL-M483 and ACPL-P483. Approval under UL 1577, component recognition program up to  $V_{ISO} = 5000V_{RMS}$  File E55361 for ACPL-W483;
- CSA: Approval under CSA Component Acceptance Notice #5, File CA 88324.

# **Package Outline Drawings**

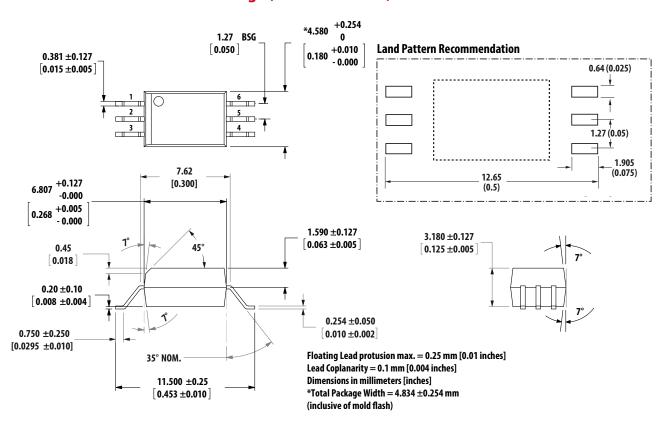
## **ACPL-M483 SO-5 Package (5 mm Creepage and Clearance)**



### ACPL-P483 Stretched SO-6 Package (7 mm Clearance) with Land Pattern Recommendation



### ACPL-W483 Stretched SO-6 Package (8 mm Clearance) with Land Pattern Recommendation



# **IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (Option 060)**

Description	Symbol	ACPL-M483	ACPL-P483	ACPL-W483	Unit
Installation classification per DIN VDE 0110/1.89, Table 1					
for rated mains voltage ≤ 150V <sub>RMS</sub>		I– IV	I– IV	I – IV	
for rated mains voltage ≤ 300V <sub>RMS</sub>		I– IV	I– IV	I– IV	
for rated mains voltage $\leq 450V_{RMS}$		I – III	I – III	I– IV	
for rated mains voltage ≤ 600V <sub>RMS</sub>		I – III	I – III	I– IV	
for rated mains voltage ≤ 1000V <sub>RMS</sub>				I– III	
Climatic Classification			55/105/21	1	
Pollution Degree (DIN VDE 0110/1.89)			2		
Maximum Working Insulation Voltage	$V_{IORM}$	567	891	1140	V <sub>peak</sub>
Input to Output Test Voltage, Method b <sup>a</sup> $V_{IORM} \times 1.875 = V_{PR}, 100\% \text{ Production Test with } t_m = 1$ sec, Partial Discharge < 5 pC	V <sub>PR</sub>	1063	1670	2137	V <sub>peak</sub>
Input to Output Test Voltage, Method a <sup>a</sup>	$V_{PR}$	907	1426	1824	V <sub>peak</sub>
$V_{IORM}$ x 1.6= $V_{PR}$ , Type and Sample Test, $t_m = 10$ sec,					
Partial Discharge < 5 pC					
Highest Allowable Overvoltage (Transient Overvoltage t <sub>ini</sub> = 60 sec)	V <sub>IOTM</sub>	6000	6000	8000	V <sub>peak</sub>
Safety-limiting Values – maximum values allowed in the	event of a fai	lure			
Case Temperature	T <sub>S</sub>		175		°C
Input Current	I <sub>S, INPUT</sub>		230		mA
Output Power	P <sub>S, OUTPUT</sub>		600		mW
Insulation Resistance at T <sub>S</sub> , V <sub>IO</sub> = 500V	R <sub>S</sub>		>109		Ω

a. Refer to the optocoupler section of the Isolation and Control Components Designer's Catalog, under the Product Safety Regulations section, (IEC/EN/DIN EN 60747-5-5), for a detailed description of Method a and Method b partial discharge test profiles.

# **Insulation and Safety Related Specifications**

Parameter	Symbol	ACPL-M483	ACPL-P483	ACPL-W483	Unit	Condition
Minimum External Air Gap (External Clearance)	L(101)	5.0	7.0	8.0	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (External Creepage)	L(102)	5.0 8.0 8.0		mm	Measured from input terminals to output terminals, shortest distance path along body.	
Minimum Internal Plastic Gap (Internal Clearance)			0.08		mm	Through insulation distance conductor to conductor, usually the straight line distance thickness between the emitter and detector.
Tracking Resistance (Comparative Tracking Index)	CTI	>175		V	DIN IEC 112/VDE 0303 Part 1.	
Isolation Group			Illa			Material Group (DIN VDE 0110, 1/89, Table 1).

# **Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit	Note	
Storage Temperature	T <sub>S</sub>	-55	+125	°C		
Operating Temperature	T <sub>A</sub>	-40	+105	°C		
Average Input Current	I <sub>F(AVG)</sub>		10	mA		
Peak Transient Input Current	I <sub>F(TRAN)</sub>					
(<1 μs pulse width, 300 pps)			1.0	Α		
(<200 μs pulse width, <1% duty cycle)			40	mA		
Reverse Input Voltage	V <sub>R</sub>		5	V		
Average Output Current	Io		50	mA		
Supply Voltage	V <sub>CC</sub>	0	35	V		
Output Voltage	V <sub>O</sub>	-0.5	35	V		
Total Package Power Dissipation (ACPL-M483)	P <sub>T</sub>		145	mW	1	
Total Package Power Dissipation	P <sub>T</sub>		210	mW	1	
Solder Reflow Temperature Profile	See reflow thermal profile					

# **Recommended Operating Conditions**

Parameter	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage <sup>a</sup>	V <sub>CC</sub>	4.5	30	V	2
Forward Input Current (ON)	I <sub>F(ON)</sub>	4	7	mA	
Forward Input Voltage (OFF)	V <sub>F(OFF)</sub>		0.8	V	
Operating Temperature	T <sub>A</sub>	-40	+105	°C	

a. Truth Table guaranteed: 4.5V to 30V

# **Electrical Specifications**

Over recommended operating conditions  $T_A = -40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ ,  $V_{CC} = 4.5\text{V}$  to 30V,  $I_{F(ON)} = 4$  mA to 7 mA,  $V_{F(OFF)} = 0\text{V}$  to 0.8V, unless otherwise specified. All typicals at  $T_A = 25^{\circ}\text{C}$ .

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Fig.	Note
Logic Low Output Voltage	V <sub>OL</sub>			0.3	V	I <sub>OL</sub> = 3.5 mA	1, 3	
		_		0.5		I <sub>OL</sub> = 6.5 mA		
Logic High Output Voltage	V <sub>OH</sub>	V <sub>CC</sub> – 0.3	V <sub>CC</sub> – 0.04		V	I <sub>OH</sub> = -3.5 mA	2, 3, 7	
		V <sub>CC</sub> – 0.5	V <sub>CC</sub> – 01.07			I <sub>OH</sub> = -6.5 mA		
Logic Low Supply Current	I <sub>CCL</sub>		1.5	3.0	mA	$V_{CC} = 5.5V$ , $I_F = 7$ mA, $I_O = 0$ mA		
			1.7	3.0	mA	$V_{CC} = 20V, I_F = 7 \text{ mA}, I_O = 0 \text{ mA}$		
Logic High Supply Current	I <sub>CCH</sub>		1.5	3.0	mA	$VCC = 5.5V, V_F = 0V, I_O = 0 \text{ mA}$		
			1.7	3.0	mA	$V_{CC} = 30V, V_F = 0V, I_O = 0 \text{ mA}$		

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Fig.	Note
Threshold Input Current Low to High	I <sub>FLH</sub>		0.8	2.2	mA			
Threshold Input Voltage High to Low	V <sub>FHL</sub>	0.8			V			
Logic Low Short Circuit	I <sub>OSL</sub>	125	200		mA	$V_O = V_{CC} = 5.5V$ , $I_F = 7$ mA, $V_O = GND$		3
Output Current		125	200		mA	$V_O = V_{CC} = 20V, I_F = 7 \text{ mA}, V_O = GND$		
Logic High Short Circuit	I <sub>OSH</sub>		-200	-125	mA	$V_{CC} = 5.5V, V_F = 0V$		3
Output Current			-200	-125	mA	$V_{CC} = 20V, V_F = 0V$		
Input Forward Voltage	V <sub>F</sub>	1.3	1.5	1.7	V	$T_A = 25^{\circ}C, I_F = 4 \text{ mA}$	4	
				1.85	V	I <sub>F</sub> = 4 mA		
Input Reverse Breakdown Voltage	BV <sub>R</sub>	5			V	I <sub>R</sub> = 10 μA		
Input Diode Temperature Coefficient	$\Delta V_F/\Delta T_A$		1.7		mV/°C	I <sub>F</sub> = 4 mA		
Input Capacitance	C <sub>IN</sub>		60		pF	f = 1 MHz, V <sub>F</sub> = 0V		4

# **Switching Specifications**

Over recommended operating conditions  $T_A = -40$ °C to +105°C,  $V_{CC} = 4.5$ V to 30V,  $I_{F(ON)} = 4$  mA to 7 mA,  $V_{F(OFF)} = 0$ V to 0.8V, unless otherwise specified. All typicals at  $T_A = 25$ °C.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Fig.	Note
Propagation Delay Time to Logic Low Output Level	t <sub>PHL</sub>		75	120	ns	$C_L = 100 \text{ pF, } I_{F(ON)} = 4 \text{ mA} -> V_F = 0V$	5, 6, 8	6
				120		Loaded as per Figure 5		
Propagation Delay Time to Logic High Output Level	t <sub>PLH</sub>		75	120	ns	$C_L = 100 \text{ pF, } V_F = 0V -> I_{F(ON)} = 4 \text{ mA}$	5, 6, 8	6
				120		Loaded as per Figure 5	1	
Pulse Width Distortion	$ t_{PHL} - t_{PLH}  = PWD$			50	ns	C <sub>L</sub> = 100 pF		9
				50		Loaded as per Figure 5	1	
Propagation Delay Difference	PDD	-100		100	ns	C <sub>L</sub> = 100 pF		10
Between Any Two Parts		-100		100		Loaded as per Figure 5		
Output Rise Time (10% to 90%)	t <sub>r</sub>		6		ns		5	
Output Fall Time (90% to 10%)	t <sub>f</sub>		6		ns		5	
Logic High Common Mode Transient Immunity	CM <sub>H</sub>	30			kV/μs	$ V_{CM}  = 1000V, I_F = 4.0 \text{ mA},$ $V_{CC} = 5V, T_A = 25^{\circ}C$	9	7
Logic Low Common Mode Transient Immunity	CM <sub>L</sub>	30			kV/μs	$ V_{CM}  = 1000V, V_F = 0V,$ $V_{CC} = 5V, T_A = 25^{\circ}C$	9	7

### **Package Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage <sup>a</sup>	V <sub>ISO</sub>	3750 (ACPL-M483/P483) 5000 (ACPL-W483)			V <sub>RMS</sub>	RH < 50%, t = 1 min. $T_A = 25^{\circ}C$		5, 8
Input-Output Resistance	R <sub>I-O</sub>		10 <sup>12</sup>		Ω	$V_{I-O} = 500V_{DC}$		5
Input-Output Capacitance	C <sub>I-O</sub>		0.6		рF	$f = 1 \text{ MHz}, V_{I-O} = 0V_{DC}$		5

a. The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the IEC/EN/DIN EN 60747-5-5 Insulation Characteristics Table (if applicable).

### **UVLO**

Figure 10 and Figure 11 show typical output waveforms during Power-up and Power-down processes.

#### Notes:

- 1. Derate total package power dissipation, PT, linearly above 70°C free-air temperature at a rate of 4.5 mW/°C (ACPL-P483/W483) and linearly above 85°C free-air temperature at a rate of 0.75 mW/°C (ACPL-M483).
- 2. Detector requires a V<sub>CC</sub> of 4.5V or higher for stable operation as output might be unstable if V<sub>CC</sub> is lower than 4.5V. Be sure to check the power ON/OFF operation other than the supply current.
- 3. Duration of output short circuit time should not exceed 500  $\mu$ s.
- 4. Input capacitance is measured between pin 1 and pin 3.
- 5. Device considered a two-terminal device: pins 1, 2, and 3 shorted together and pins 4, 5, and 6 shorted together.
- 6. The t<sub>PLH</sub> propagation delay is measured from the 50% point on the leading edge of the input pulse to the 1.3V point on the leading edge of the output pulse. The t<sub>PHL</sub> propagation delay is measured from the 50% point on the trailing edge of the input pulse to the 1.3 V point on the trailing edge of the output pulse.
- 7.  $CM_H$  is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic high state,  $V_O > 2.0V$ .  $CM_L$  is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic low state,  $V_O < 0.8V$ . Note: Equal value split resistors (Rin/2) must be used at both ends of the LED.
- 8. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage.  $4500V_{RMS}$  for one second (leakage detection current limit,  $I_{I-O} \le 5 \mu A$ ). This test is performed before the 100% production test for partial discharge (Method b) shown in the IEC/EN/DIN EN 60747-5-5 Insulation Characteristics Table, if applicable.
- 9. Pulse Width Distortion (PWD) is defined as  $\left|t_{PHL}-t_{PLH}\right|$  for any given device.
- 10. The difference of  $t_{PLH}$  and  $t_{PHL}$  between any two devices under the same test condition.
- 11. Use of a 0.1  $\mu$ F bypass capacitor connected between pins  $V_{CC}$  and Ground is recommended.

Figure 1 Typical Logic Low Output Voltage vs. Temperature

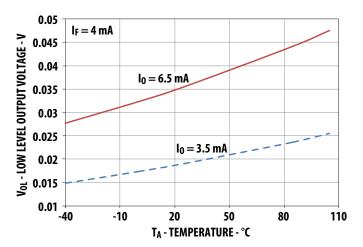


Figure 2 Typical Logic High Output Current vs. Temperature

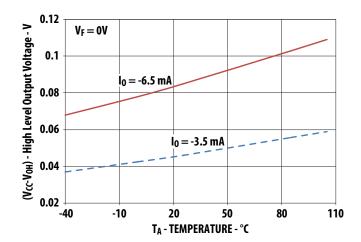


Figure 3 Typical Output Voltage vs. Forward Input Current

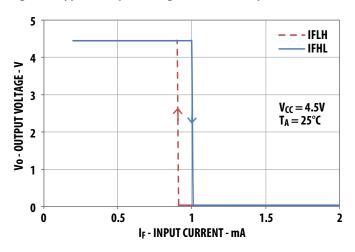


Figure 4 Typical Input Diode Forward Characteristic

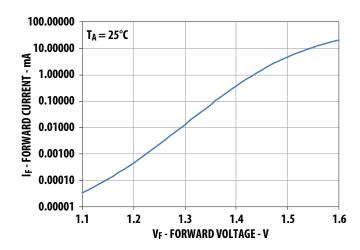
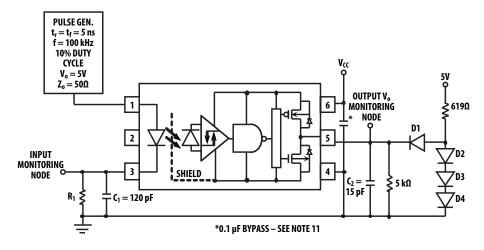


Figure 5 Test Circuit for  $t_{PLH}$ ,  $t_{PHL}$ ,  $t_{r}$ , and  $t_{f}$ 



THE PROBE AND JIG CAPACITANCES ARE INCLUDED IN C1 AND C2.

R1 820Ω 560Ω

I<sub>F(ON)</sub> 4 mA 7 mA

ALL DIODES ARE EITHER 1N916 OR 1N3064

INPU<u>T I<sub>F</sub></u>

0 mA

OUTPUT V

V<sub>OH</sub>

V<sub>OL</sub> (OV)

Figure 6 Typical Propagation Delays vs. Temperature

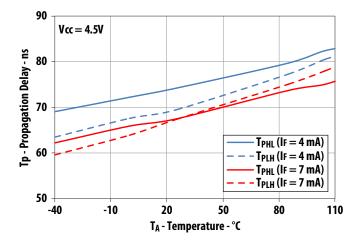


Figure 7 Typical Logic High Output Voltage vs. Supply Voltage

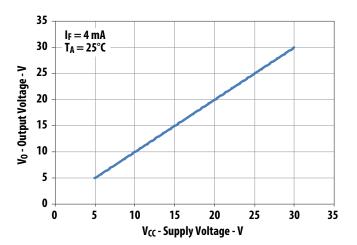


Figure 8 Typical Propagation Delay vs. Supply Voltage

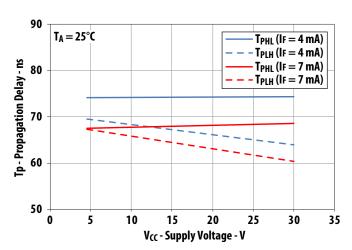


Figure 9 Test Circuit for Common Mode Transient Immunity and Typical Waveforms

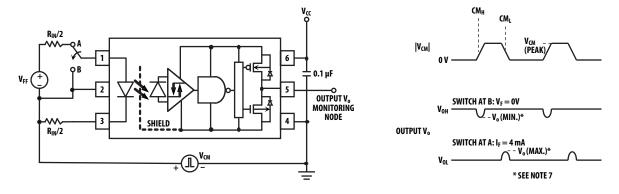


Figure 10  $\,V_{CC}$  Ramp When LED ON

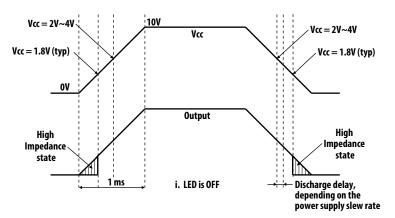
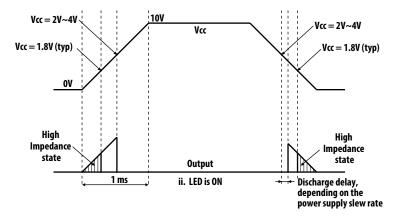


Figure 11  $\,V_{CC}$  Ramp When LED OFF



# Thermal Model for ACPL-M483 SO-5 Package Optocoupler

### **Definitions**

- R<sub>11</sub>: Junction to Ambient Thermal Resistance of LED due to heating of LED
- R<sub>12</sub>: Junction to Ambient Thermal Resistance of LED due to heating of Detector (Output IC)
- R<sub>21</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of LED.
- R<sub>22</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of Detector (Output IC).
- P<sub>1</sub>: Power dissipation of LED (W).
- P<sub>2</sub>: Power dissipation of Detector/Output IC (W).
- $T_1$ : Junction temperature of LED (°C).
- T<sub>2</sub>: Junction temperature of Detector (°C).
- T<sub>a</sub>: Ambient temperature.
- $\Delta T_1$ : Temperature difference between LED junction and ambient (°C).
- ΔT<sub>2</sub>: Temperature deference between Detector junction and ambient.
- Ambient Temperature: Junction to Ambient Thermal Resistances were measured approximately 1.25 cm above optocoupler at ~23°C in still air

#### Description

This thermal model assumes that an 5-pin single-channel plastic package optocoupler is soldered into a 7.62 cm x 7.62 cm printed circuit board (PCB). The temperature at the LED and Detector junctions of the optocoupler can be calculated using the equations below.

$$T_1 = (R_{11} \times P_1 + R_{12} \times P_2) + T_a - (1)$$

$$T_2 = (R_{21} \times P_1 + R_{22} \times P_2) + T_a - (2)$$

JEDEC Specifications	R11	R12, R21	R22
Low K board	191	77, 91	99
High K board	126	26, 35	51

Note: Maximum junction temperature for above parts: 125°C.

# Thermal Model for ACPL-P483/W483 SO-6 Package Optocoupler

### **Definitions**

- R<sub>11</sub>: Junction to Ambient Thermal Resistance of LED due to heating of LED
- R<sub>12</sub>: Junction to Ambient Thermal Resistance of LED due to heating of Detector (Output IC)
- R<sub>21</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of LED.
- R<sub>22</sub>: Junction to Ambient Thermal Resistance of Detector (Output IC) due to heating of Detector (Output IC).
- P<sub>1</sub>: Power dissipation of LED (W).
- P<sub>2</sub>: Power dissipation of Detector/Output IC (W).
- T<sub>1</sub>: Junction temperature of LED (°C).
- $T_2$ : Junction temperature of Detector (°C).
- T<sub>a</sub>: Ambient temperature.
- $\Delta T_1$ : Temperature difference between LED junction and ambient (°C).
- lacksquare  $\Delta T_2$ : Temperature deference between Detector junction and ambient.
- Ambient Temperature: Junction to Ambient Thermal Resistances were measured approximately 1.25 cm above optocoupler at ~23°C in still air

#### Description

This thermal model assumes that an 6-pin single-channel plastic package optocoupler is soldered into a 7.62 cm x 7.62 cm printed circuit board (PCB). The temperature at the LED and Detector junctions of the optocoupler can be calculated using the equations below.

$$T_1 = (R_{11} \times P_1 + R_{12} \times P_2) + T_a - (1)$$

$$T_2 = (R_{21} \times P_1 + R_{22} \times P_2) + T_a - (2)$$

JEDEC Specifications	R11	R12, R21	R22
Low K board	167	64, 81	89
High K board	117	31, 39	54

Note: Maximum junction temperature for above parts: 125°C.

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AV02-3216EN - November 10, 2017





# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

### **Broadcom Limited:**

<u>ACPL-W483-560E</u> <u>ACPL-M483-060E</u> <u>ACPL-M483-000E</u> <u>ACPL-W483-500E</u> <u>ACPL-W483-060E</u> <u>ACPL-W483-060E</u> <u>ACPL-P483-060E</u> <u>ACPL-P483-060E</u> <u>ACPL-P483-560E</u> <u>ACPL-</u>